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 SVN Rev: Version control disabled
 Drawn By: Helen Chen
 Engineer: Helen Chen

Designed for: Public Release	Mod. Date: 1/4/2017
Project Title: precise current limit circuit for the TPS61088 Boost	
Sheet Title: PMP9806	
Assembly Variant: 001	Sheet: 1 of 2
File: PMP9806.SchDoc	Size: A4
Contact: http://www.ti.com/support	



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PCB Number: PMP9806
PCB Rev: A

PCB
LOGO
Texas Instruments

ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Number: [PMP9806](#) Rev: [A](#)
SVN Rev: Version control disabled
Drawn By:
Engineer: [Helen Chen](#)

Designed for: Public Release	Mod. Date: 11/24/2016
Project Title: precise current limit circuit for the TPS61088 Boost	
Sheet Title:	
Assembly Variant: 001	Sheet: 2 of 2
File: PMP9806_Hardware.SchDoc	Size: A4
Contact: http://www.ti.com/support	



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